



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. ....10/666,025  
Filing Date .....September 17, 2003  
Inventor ..... Cem Basceri  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 1762  
Examiner ..... Timothy Howard Meeks  
Attorney's Docket No. .... MI22-2407  
Title ..... Plasma Enhanced Chemical Vapor Deposition Method of Forming  
a Titanium Silicide Comprising Layer

**TERMINAL DISCLAIMER**

I, Mark S. Matkin, residing at Spokane, Washington, represent that I am the attorney of record for Micron Technology, Inc., a corporation of the state of Delaware. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/666,025, filed September 17, 2003, as evidenced by an assignment recorded on March 6, 2002, at Reel 012686 in Frames 0294-0299 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all rights, title and interest in U.S. Patent No. 6,586,285 and U.S. Patent No. 6,734,051 as evidenced by an assignment recorded on March 6, 2002 at Reel 012686 in Frames 0329-0334 in the U.S. Patent and Trademark Office.

The evidentiary documents have been reviewed, and I certify that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

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Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/666,025 which extends beyond the expiration date of U.S. Patent No. 6,586,285 and U.S. Patent No. 6,734,051 and further hereby agrees that any future patent so granted on this U.S. Patent Application Serial No. 10/666,025 shall be enforceable only for and during such period that the legal title on the U.S. Patent No. 6,586,285 and the U.S. Patent No. 6,734,051 shall be the same as the legal title to any patent issued from U.S. Patent Application Serial No. 10/666,025. This agreement is to run with any patent granted on the application and is to be binding upon the grantee of such patent and its successors or assigns.


Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/666,025 application prior to the expiration date of the full statutory term of the United States Patent No. 6,586,285 or the United States Patent No. 6,734,051 in the event that either later: expires for failure to pay a maintenance fee, is held unenforceable, is found invalid by a court of competent jurisdiction, is statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. § 1.321(a), has all claims canceled by a reexamination certificate, is reissued in any matter or is otherwise terminated prior to expiration of its full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. § 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, Mark S. Matkin, hereby indicates that he is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Dated: 2-17-05

By:   
Mark S. Matkin  
Reg. No. 32,268